

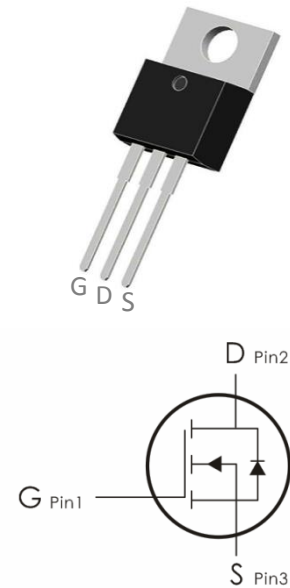
## Description:

This N-Channel MOSFET uses advanced trench technology and design to provide excellent  $R_{DS(on)}$  with low gate charge.

It can be used in a wide variety of applications.

## Features:

- 1)  $V_{DS}=80V, I_D=160A, R_{DS(ON)} < 4.7m\Omega @ V_{GS}=10V$
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra  $R_{DS(ON)}$ .
- 5) Excellent package for good heat dissipation.



## Absolute Maximum Ratings: ( $T_C=25^\circ C$ unless otherwise noted)

| Symbol         | Parameter                                        | Ratings     | Units      |
|----------------|--------------------------------------------------|-------------|------------|
| $V_{DS}$       | Drain-Source Voltage                             | 80          | V          |
| $V_{GS}$       | Gate-Source Voltage                              | $\pm 20$    | V          |
| $I_D$          | Continuous Drain Current- $T_C=25^\circ C$       | 160         | A          |
|                | Continuous Drain Current- $T_C=100^\circ C$      | 113         |            |
|                | Pulsed Drain Current                             | 500         |            |
| $E_{AS}$       | Single Pulse Avalanche Energy <sup>5</sup>       | 1936        | mJ         |
| $P_D$          | Power Dissipation                                | 285         | W          |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range | -55 to +175 | $^\circ C$ |

## Thermal Characteristics:

| Symbol          | Parameter                                         | Max  | Units        |
|-----------------|---------------------------------------------------|------|--------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case <sup>2</sup> | 0.53 | $^\circ C/W$ |

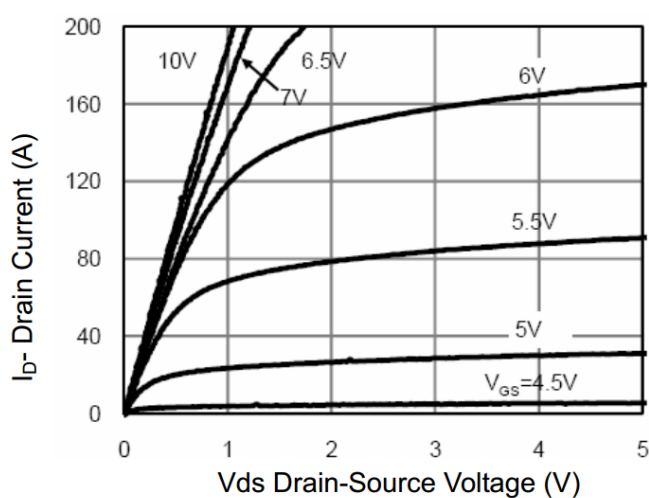
## Electrical Characteristics: ( $T_C=25^{\circ}\text{C}$ unless otherwise noted)

| Symbol                                 | Parameter                                       | Conditions                                                                                                      | Min | Typ  | Max   | Units |
|----------------------------------------|-------------------------------------------------|-----------------------------------------------------------------------------------------------------------------|-----|------|-------|-------|
| Off Characteristics                    |                                                 |                                                                                                                 |     |      |       |       |
| BV <sub>DSS</sub>                      | Drain-Source Breakdown Voltage                  | V <sub>GS</sub> =0V, I <sub>D</sub> =250 μ A                                                                    | 80  | 88   | ---   | V     |
| I <sub>DSS</sub>                       | Zero Gate Voltage Drain Current                 | V <sub>GS</sub> =0V, V <sub>DS</sub> =80V                                                                       | --- | ---  | 1     | μ A   |
| I <sub>GSS</sub>                       | Gate-Source Leakage Current                     | V <sub>GS</sub> =± 20V, V <sub>DS</sub> =0A                                                                     | --- | ---  | ± 100 | nA    |
| On Characteristics <sup>3</sup>        |                                                 |                                                                                                                 |     |      |       |       |
| V <sub>GS(th)</sub>                    | GATE-Source Threshold Voltage                   | V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250 μ A                                                      | 2   | 3    | 4     | V     |
| R <sub>DS(ON)</sub>                    | Drain-Source On Resistance                      | V <sub>GS</sub> =10V, I <sub>D</sub> =20A                                                                       | --- | 3.7  | 4.7   | m Ω   |
| G <sub>FS</sub>                        | Forward Transconductance                        | V <sub>DS</sub> =5V, I <sub>D</sub> =20A                                                                        | 60  | ---  | ---   | S     |
| Dynamic Characteristics <sup>4</sup>   |                                                 |                                                                                                                 |     |      |       |       |
| C <sub>iss</sub>                       | Input Capacitance                               | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz                                                               | --- | 6500 | ---   | pF    |
| C <sub>oss</sub>                       | Output Capacitance                              |                                                                                                                 | --- | 810  | ---   |       |
| C <sub>rss</sub>                       | Reverse Transfer Capacitance                    |                                                                                                                 | --- | 310  | ---   |       |
| Switching Characteristics <sup>4</sup> |                                                 |                                                                                                                 |     |      |       |       |
| t <sub>d(on)</sub>                     | Turn-On Delay Time                              | V <sub>DD</sub> =40V, I <sub>D</sub> =2A, R <sub>L</sub> =15Ω<br><br>V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω | --- | 31.5 | ---   | ns    |
| t <sub>r</sub>                         | Rise Time                                       |                                                                                                                 | --- | 33   | ---   | ns    |
| t <sub>d(off)</sub>                    | Turn-Off Delay Time                             |                                                                                                                 | --- | 46   | ---   | ns    |
| t <sub>f</sub>                         | Fall Time                                       |                                                                                                                 | --- | 17.5 | ---   | ns    |
| Q <sub>g</sub>                         | Total Gate Charge                               | V <sub>GS</sub> =10V, V <sub>DS</sub> =40V,<br><br>I <sub>D</sub> =20A                                          | --- | 130  | ---   | nC    |
| Q <sub>gs</sub>                        | Gate-Source Charge                              |                                                                                                                 | --- | 36   | ---   | nC    |
| Q <sub>gd</sub>                        | Gate-Drain “Miller” Charge                      |                                                                                                                 | --- | 46   | ---   | nC    |
| Drain-Source Diode Characteristics     |                                                 |                                                                                                                 |     |      |       |       |
| V <sub>SD</sub>                        | Source-Drain Diode Forward Voltage <sup>3</sup> | V <sub>GS</sub> =0V, I <sub>S</sub> =40A                                                                        | --- | ---  | 1.2   | V     |

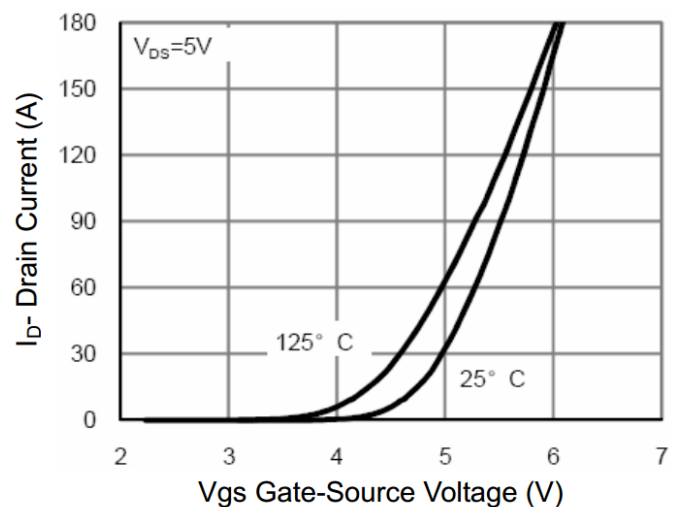
## Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300 \mu s$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition:  $T_j=25^\circ\text{C}$ ,  $V_{DD}=40\text{V}$ ,  $V_G=10\text{V}$ ,  $L=0.5\text{mH}$ ,  $R_g=25\Omega$

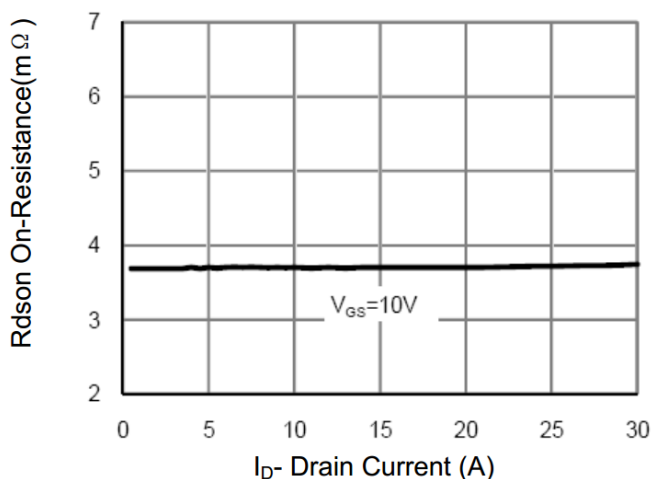
## Typical Characteristics: ( $T_c=25^\circ\text{C}$ unless otherwise noted)



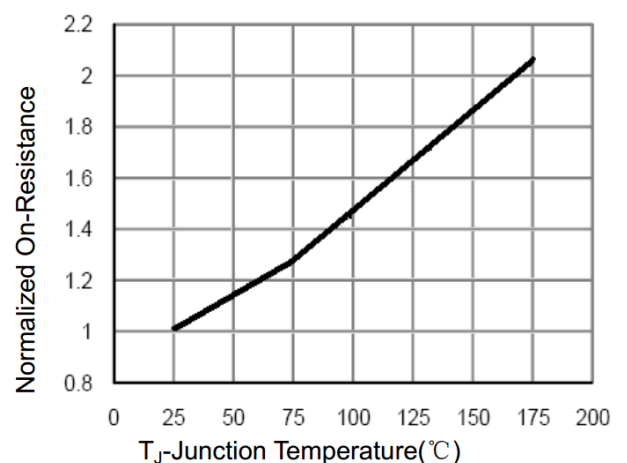
**Figure 1 Output Characteristics**



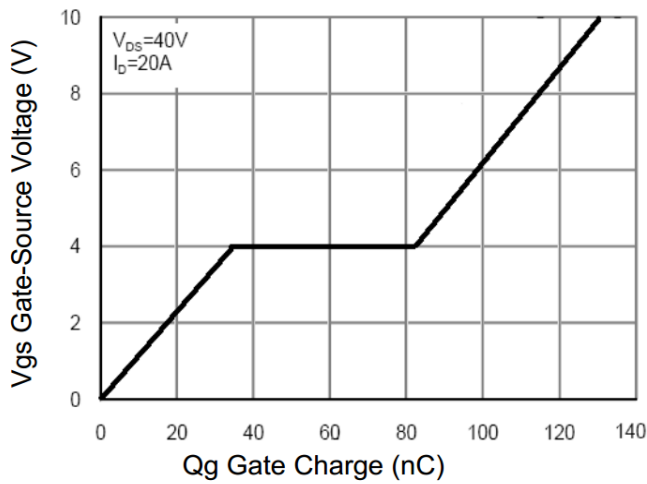
**Figure 2 Transfer Characteristics**



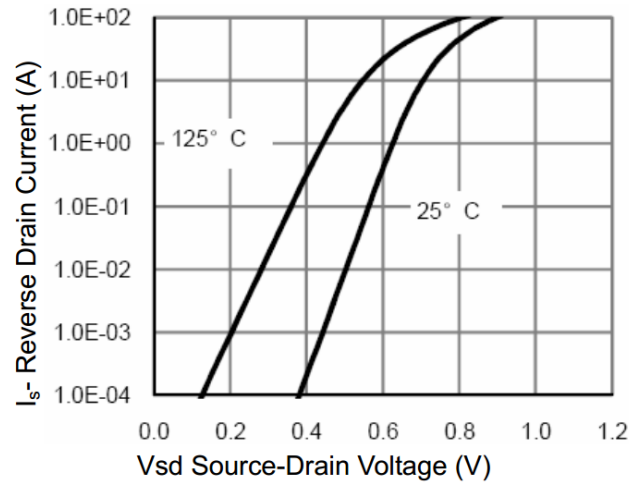
**Figure 3 Rdson- Drain Current**



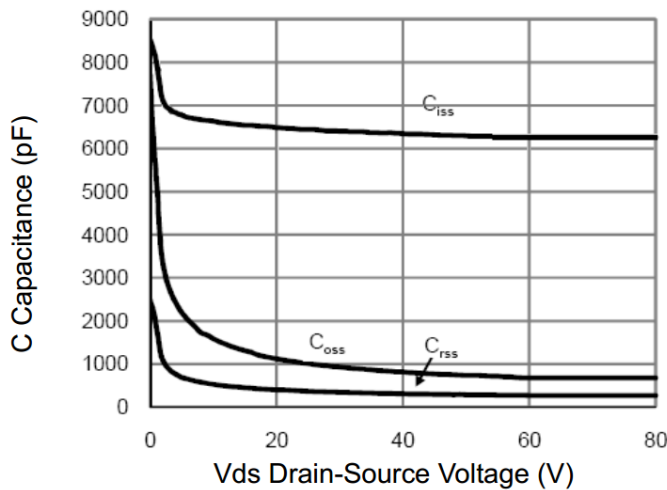
**Figure 4 Rdson-Junction Temperature**



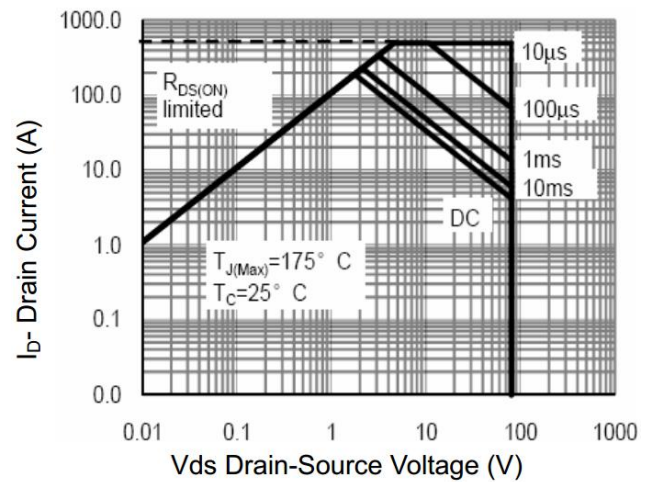
**Figure 5 Gate Charge**



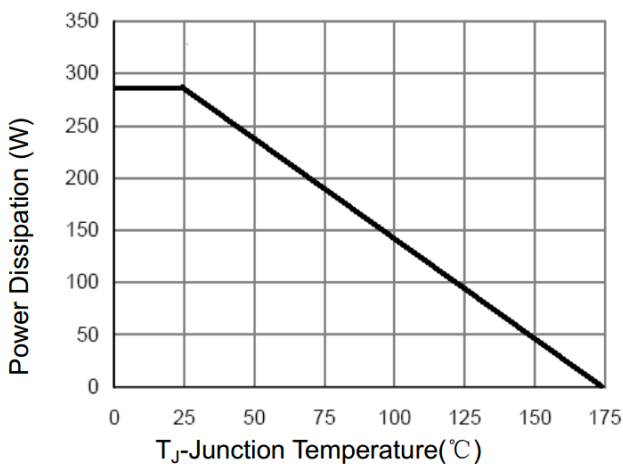
**Figure 6 Source- Drain Diode Forward**



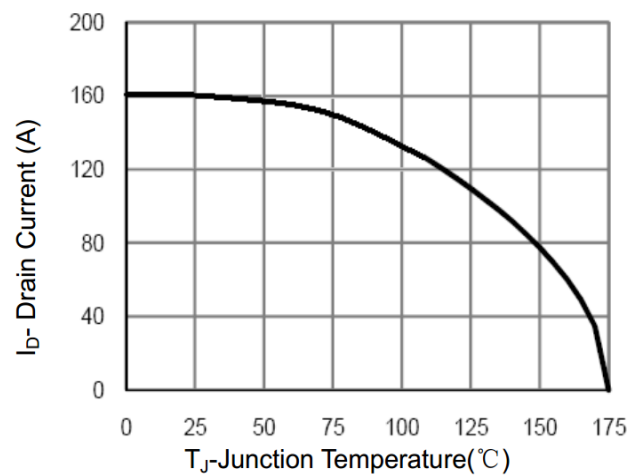
**Figure 7 Capacitance vs Vds**



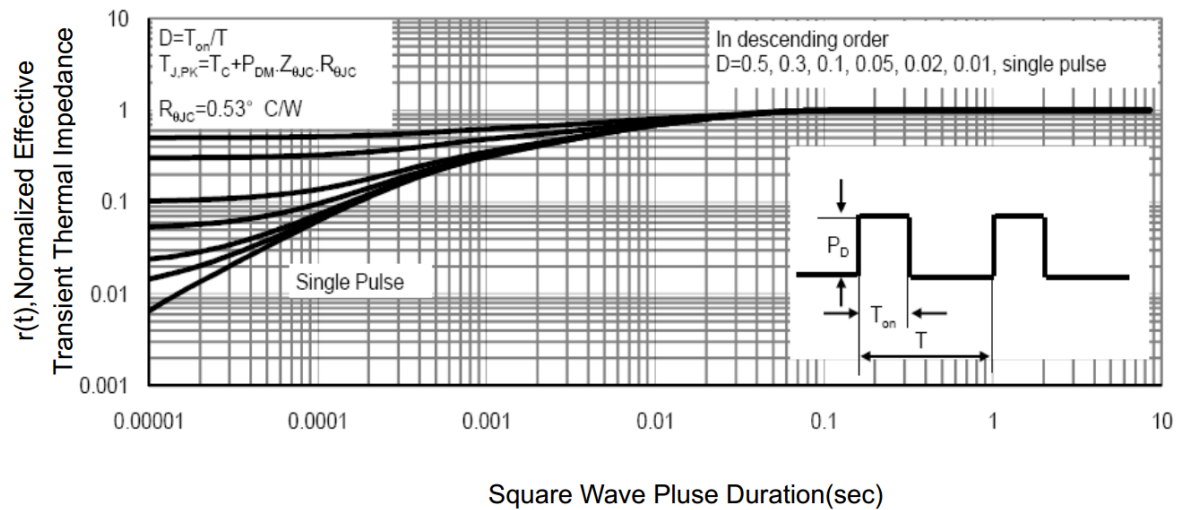
**Figure 8 Safe Operation Area**



**Figure 9 Power De-rating**



**Figure 10 Current De-rating**



**Figure 11 Normalized Maximum Transient Thermal Impedance**



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